

# PMEG100V100ELPD

100 V, 10 A low leakage current Schottky barrier rectifier
4 October 2016 Product data sheet

## 1. General description

Maximum Efficiency General Application (MEGA) Schottky barrier rectifier, encapsulated in a CFP15 (SOT1289) power and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 10 A
- Reverse voltage: V<sub>R</sub> ≤ 100 V
- · Low leakage current due to high Schottky barrier technology
- Low forward voltage
- High power capability due to clip-bonding technology and heat sink
- High temperature T<sub>i</sub> ≤ 175 °C
- Small and thin SMD power plastic package, typical height 0.78 mm
- AEC-Q101 qualified

### 3. Applications

- Low voltage rectification
- Automotive LED lighting
- High efficiency DC-to-DC conversion
- Switch mode power supply
- · Reverse polarity protection
- Low power consumption application

#### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; f = 20 kHz; $T_{amb} \le 150$ °C; square wave	-	-	10	Α
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	-	100	٧
V <sub>F</sub>	forward voltage	$I_F = 10 \text{ A; } t_p \le 300  \mu\text{s; } \delta \le 0.02 \text{ ; } T_j = 25 \text{ °C}$	-	770	850	mV
I <sub>R</sub>	reverse current	$V_R = 100 \text{ V}; t_p \le 3 \text{ ms}; T_j = 25 \text{ °C}; \delta \le 0.03$	-	0.2	0.8	μΑ



## 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	Α	anode		⊬ <b>P</b> A
2	Α	anode	3	A aaa-009063
3	K	cathode	2	<b>344</b> 55555
			CFP15 (SOT1289)	

## 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package				
	Name	Description	Version		
PMEG100V100ELPD	CFP15	plastic, thermal enhanced ultra thin SMD package; 3 leads; body: 5.8 x 4.3 x 0.78 mm	SOT1289		

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code			
PMEG100V100ELPD	100V L10E			

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	100	V
l <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 145 °C; δ = 1		-	14	Α
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5 ; f = 20 kHz; $T_{amb} \le 150 ^{\circ}\text{C}$ ; square wave		-	10	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	170	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
			[3]	-	3.75	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [3] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

#### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
uig-a)	thermal resistance from junction to ambient	in free air	[1][2]	-	-	90	K/W
			[1][3]	-	-	70	K/W
			[1][4]	-	-	40	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		<u>[5]</u>	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

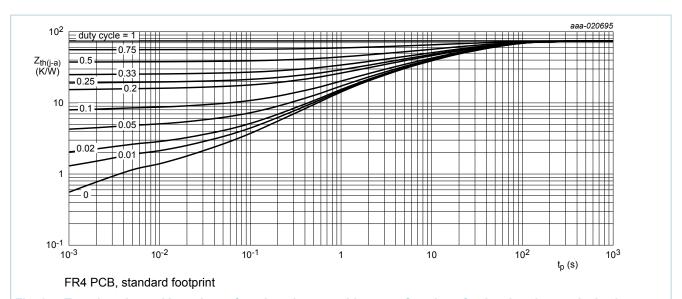


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

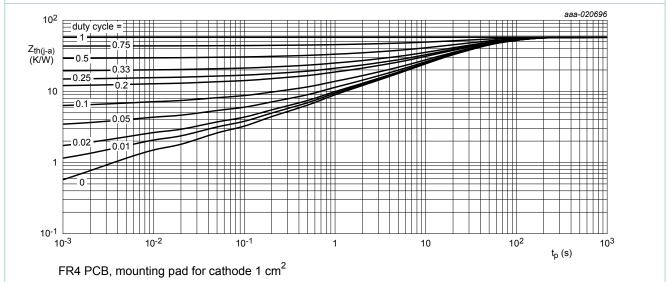
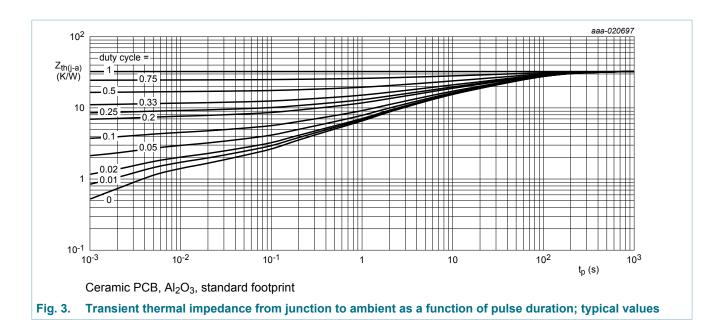


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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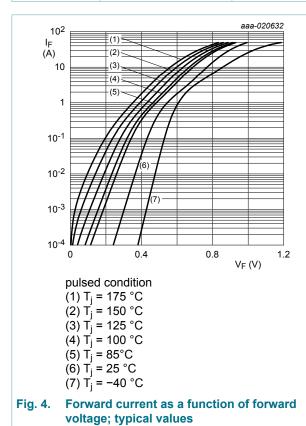


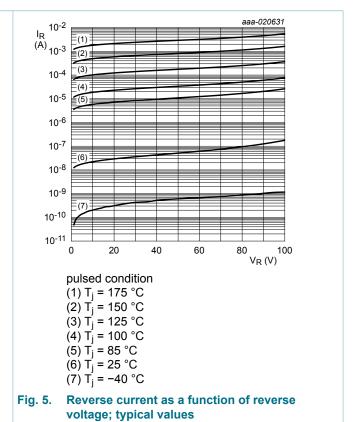
### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)R</sub>	reverse breakdown voltage	$I_R$ = 1 mA; $t_p \le 1.2$ ms; $\delta \le 0.12$ ; $T_j$ = 25 °C; pulsed	100	-	-	V
V <sub>F</sub>	forward voltage	$I_F$ = 0.1 A; $t_p \le 300 \ \mu s$ ; $\delta \le 0.02$ ; $T_j$ = 25 °C	-	440	-	mV
		$I_F$ = 1 A; $t_p \le 300 \text{ μs}$ ; $\delta \le 0.02 \text{ ;}$ $T_j$ = 25 °C	-	545	650	mV
		$I_F = 2 \text{ A}; t_p \le 300  \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	610	710	mV
		$I_F = 4 \text{ A}; t_p \le 300  \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	685	-	mV
		$I_F$ = 5 A; $t_p \le 300 \text{ μs}$ ; $\delta \le 0.02 \text{ ;}$ $T_j$ = 25 °C	-	700	790	mV
		$I_F$ = 6 A; $t_p \le 300 \text{ μs}$ ; $\delta \le 0.02 \text{ ;}$ $T_j$ = 25 °C	-	720	-	mV
		$I_F$ = 8 A; $t_p \le 300 \text{ μs}$ ; $\delta \le 0.02 \text{ ;}$ $T_j$ = 25 °C	-	745	-	mV
		$I_F$ = 10 A; $t_p$ ≤ 300 μs; δ ≤ 0.02 ; $T_j$ = 25 °C	-	770	850	mV
		$I_F$ = 10 A; $t_p$ ≤ 300 μs; δ ≤ 0.02 ; $T_j$ = -40 °C	-	870	960	mV
		$I_F$ = 5 A; $t_p \le 300 \text{ μs}$ ; $\delta \le 0.02 \text{ ;}$ $T_j$ = 125 °C	-	570	-	mV
		$I_F$ = 10 A; $t_p \le 300 \ \mu s$ ; $\delta \le 0.02$ ; $T_j$ = 125 °C	-	635	730	mV

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>R</sub>	reverse current	$V_R = 60 \text{ V}; t_p \le 3 \text{ ms}; T_j = 25 \text{ °C}; \delta \le 0.03$	-	0.06	-	μΑ
		$V_R = 80 \text{ V; } t_p \le 3 \text{ ms; } T_j = 25 \text{ °C; } \delta \le 0.03$	-	0.09	-	μΑ
		$V_R = 100 \text{ V}; t_p \le 3 \text{ ms}; T_j = 25 \text{ °C}; \delta \le 0.03$	-	0.2	0.8	μΑ
		$V_R = 100 \text{ V}; t_p \le 3 \text{ ms}; T_j = 125 \text{ °C}; \delta \le 0.03$	-	0.38	2.5	mA
		$V_R = 60 \text{ V; } t_p \le 3 \text{ ms; } T_j = 150 \text{ °C; } \delta \le 0.03$	-	0.92	3.5	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	365	-	pF
		V <sub>R</sub> = 4 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	215	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	135	-	pF
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(meas)} = 0.1 \text{ A}$ ; $T_j = 25 \text{ °C}$	-	14	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	555	-	mV





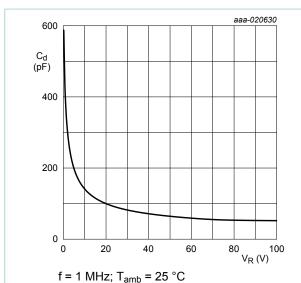


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

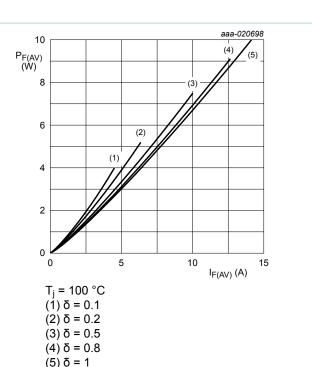


Fig. 7. Average forward power dissipation as a function of average forward current; typical values

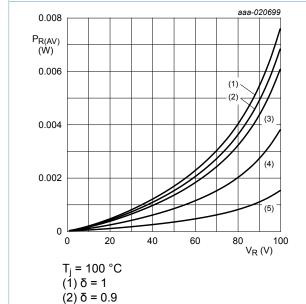
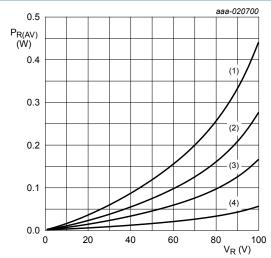


Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values

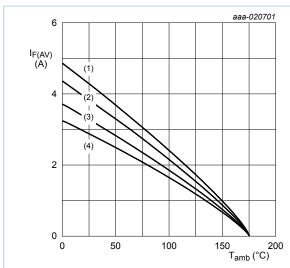


 $T_j = 175 \,^{\circ}\text{C}$   $(1) \, \delta = 1$   $(2) \, \delta = 0.5$   $(3) \, \delta = 0.2$  $(4) \, \delta = 0.1$ 

Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values

 $(3) \delta = 0.8$  $(4) \delta = 0.5$ 

 $(5) \delta = 0.2$ 



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$ 

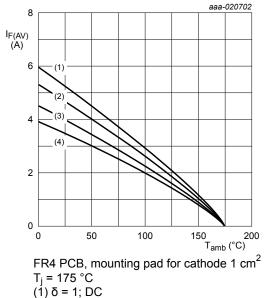
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values

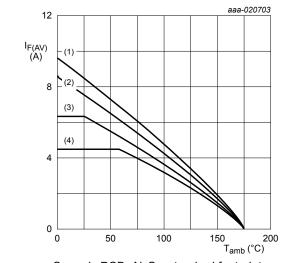


(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 175 °C

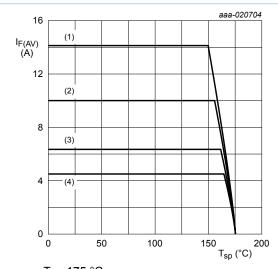
 $(1) \delta = 1 (DC)$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



 $T_i = 175 \, ^{\circ}C$ 

 $(1) \delta = 1 (DC)$ 

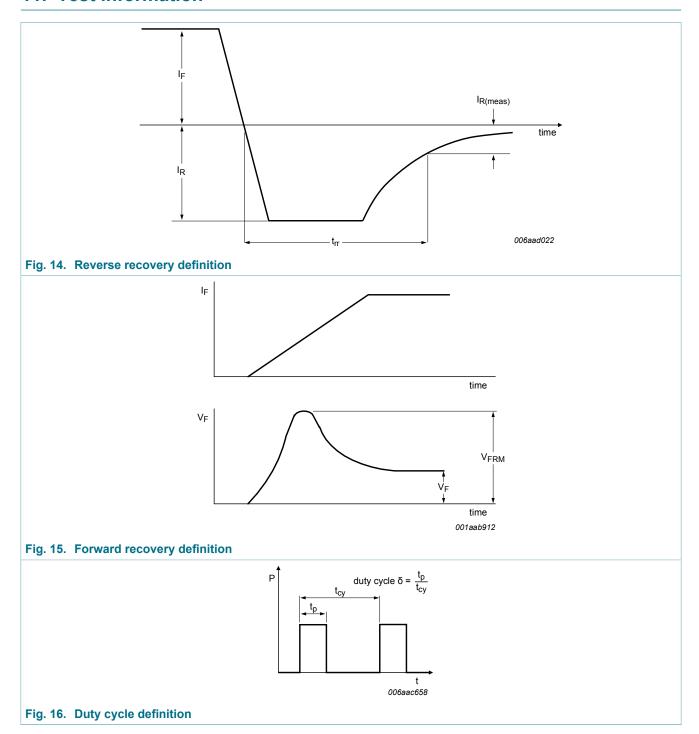
(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta$  = 0.2; f = 20 kHz

(4)  $\delta$  = 0.1; f = 20 kHz

Fig. 13. Average forward current as a function of solder point temperature; typical values

#### 11. Test information



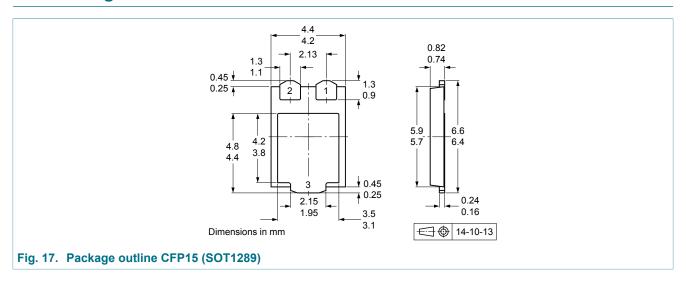
The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_{M} \times \delta$  with  $I_{M}$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

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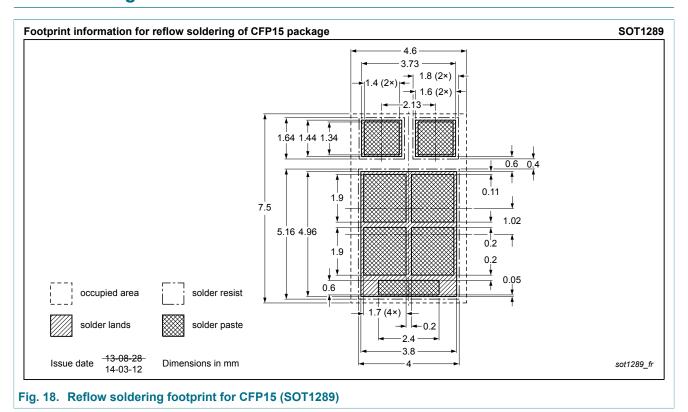
#### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 12. Package outline



## 13. Soldering



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## 14. Revision history

#### Table 8. Revision history

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Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG100V100ELPD v.3	20161004	Product data sheet	-	PMEG100V100ELPD v.2			
Modifications:	Updated I <sub>R</sub> max	• Updated I <sub>R</sub> maximum value at 100 V, 25 °C					
PMEG100V100ELPD v.2	20160203	Product data sheet	-	PMEG100V100ELPD v.1			
PMEG100V100ELPD v.1	20151117	Preliminary data sheet	-	-			

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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